

Welcome to the CHIPS Incentives Program Portal

Use this portal to apply for CHIPS Incentives or submit a Statement of Interest. To get started or to log in to an existing account, click on the button in the upper right corner of the screen.

This portal supports the National Institute of Standards and Technology, a bureau of the U.S. Department of Commerce, in the administration of the CHIPS Incentives Program, which is part of CHIPS for America (<https://www.chips.gov>). The CHIPS Incentives Program can provide direct funding (via grants, cooperative agreements, or other transactions), loans, and loan guarantees (collectively, “CHIPS Incentives”) for eligible projects.

Learn more (<https://nist.gov/chips/notice-funding-opportunity-commercial-fabrication-facilities>) about the program objectives and requirements applicants will need to meet to receive funding.



Resources

Before you apply, please read the CHIPS Incentives Program Notice of Funding Opportunity (NOFO) for Commercial Fabrication Facilities (<https://nist.gov/chips/notice-funding-opportunity-commercial-fabrication-facilities>). The NOFO provides detailed information about the program objectives and requirements applicants will need to meet to receive funding. It also describes the procedures the Department will use to evaluate and select applications for funding.

Resources (8)

[Workforce Development and Child Care Planning Guide](#)

[Additional guides and templates](#)

[Sam.gov](#)

[Informational Webinars](#)

[Frequently Asked Questions](#)

[Grants.gov](#)

[Vision for Success: Commercial Fabrication Facilities](#)

User Support

For issues related to the CHIPS Incentives Portal such as logging in, adding additional users, navigating the website or application intake system, uploading forms or templates, please contact apply@chips.gov.

For program-related questions, including program guidelines in the Notice of Funding Opportunity (NOFO), the application or application forms and templates, questions on program eligibility including eligible program costs or activities, the application review process, program technical assistance, please contact the program team at apply@chips.gov.

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Welcome, Austin Fadely

My Incentives Request(s)

Funding Request Name: Austin - CHIPS-000360
Stage: Statement of Interest
Status: Open

[View Application](#)

Funding Request Name: Austin - CHIPS-000374
Stage: Statement of Interest
Status: Open

[View Application](#)

 [Start Your Submission](#)

Any communication, data, or other information stored or transmitted on this system may be disclosed or used for any lawful Government purpose. This includes, but is not limited to, statutorily required disclosures to other Executive Branch agencies or offices, Congress, and the U.S. Government Accountability Office pursuant to 15 U.S.C § 4652.

By voluntarily furnishing information through this system, you are indicating your consent for the CHIPS Program Office to use the information you submit for the purposes stated.

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OMB Control Number: 0693-XXXX

Expiration Date: XX/XX/XXXX

[View Burden Statement](#)

Statement of Interest



Ackno

Acknowledgement

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 I acknowledge the above statement.

Submi

[Next](#)

Pre-Application

Acknowledgement

SECTION STATUS

Not Started

Cover Page

SECTION STATUS

Not Started

Project Plan

SECTION STATUS

Not Started

Potential Applicant Information

Consistent with the CHIPS Incentive Program Notice of Funding Opportunity, NIST will treat the submitted application as confidential business information (CBI) which will automatically be labeled as Controlled Unclassified Information (CUI//PROPIN). As a result, NIST will strive to protect the submitted application by applying security controls commensurate with the FIPS-199 moderate for confidentiality level.

* Potential Applicant Name

Corporate Parent Name

Have you registered for a [SAM.gov](#) account?

* Response 

An active [SAM.gov](#) registration is required to receive a CHIPS Incentive award; CPO recommends beginning the registration process as soon as possible.

Are there other entities (e.g., customers, suppliers, investors, advisors) you anticipate partnering with in a meaningful way?

* Response 

✓ Contact Information

* First Name

* Last Name

* Title

* Phone


* Email

* Street1

Street2

Steps

Potential Applicant Information

 Project Information

 Generate PDF

 Confirmation

Project Information

Project(s) Description, i.e. description of the construction, expansion, or modernization activities for each proposed facility at a single location; resulting products that will be manufactured, along with information on the scale, size, and capacity of production, and any known timelines (max. 1500 characters)

* Response

Product End Market Application, i.e., description of the types of customers and which end markets will be served by the technology being produced from each proposed facility (max. 500 characters)

* Response

Site Location

* City

* State

* ZIP code

Not Determined At This Time

Project Type(s)

* Response ?

Facility Type(s) (Please select all that apply)

* Response ?

- Leading-Edge Facilities
- Current-Generation Facilities
- Mature Node Facilities
- Back-End Production Facilities
- Semiconductor Materials and Manufacturing Equipment Facilities
- Research and Development Facilities
- Other

Steps

- Potential Applicant Information
- Project Information**
- Generate PDF
- Confirmation

- Back-End Production Facilities
- Semiconductor Materials and Manufacturing Equipment Facilities
- Research and Development Facilities
- Other

If other, please specify

Product Information - Leading-Edge Facilities selected

Technology Segment (Leading-Edge Facilities)

* Response

Logic (below 5nm processes) ▼

Expected Total Capital Expenditures for all proposed projects - Please provide the narrowest range possible:

* Minimum ⓘ

\$ 1,500,000.00

* Maximum ⓘ

\$ 2,000,000.00

Optional commentary on range provided for Expected Total Capital Expenditures (max. 500 characters)

Response

Estimated peak monthly unit production capacity (e.g. wafers per month, components per month)

* Quantity

1500

Not Applicable

Please specify unit used

* Unit

Wafers

CHIPS Application Information

Do you expect your next submission to be a pre-application or full application? The Department strongly encourages pre-applications for potential applicants for current-generation, mature-node, or back-end productions facilities and for potential applicants that are in earlier stages of application development.

* Response

Optional commentary on range provided for Expected Total Capital Expenditures (max. 500 characters)

Response

Estimated peak monthly unit production capacity (e.g. wafers per month, components per month)

*Quantity

Not Applicable

Please specify unit used

*Unit

CHIPS Application Information

Do you expect your next submission to be a pre-application or full application? The Department strongly encourages pre-applications for potential applicants for current-generation, mature-node, or back-end productions facilities and for potential applicants that are in earlier stages of application development.

*Response

Expected Timeline for Next Submission (Month) (for submission dates, refer to Executive Summary in the CHIPS-CFF NOFO)

*Month

Expected Timeline for Next Submission (Year) (for submission dates, refer to Executive Summary in the CHIPS-CFF NOFO)

*Year

Is there any other information about the potential application that we should know? (max. 1500 characters)

Previous

Finish

Full Ap

Acknowledgement

SECTION STATUS
Not Started

Get Started

Attest and Submit

Use of Information

Information submitted in the Statement of Interest (SOI) is being provided to the U.S. Department of Commerce (DOC) for informational and planning purposes. Any information contained in the SOI will not become part of any subsequent application package or be used as part of the award review and selection process; further, the contents of this submission shall not be considered binding and the potential applicant may change any information provided in the SOI as part of any subsequent Pre-Application and Full Application submissions.

DOC recognizes the importance of protecting confidential business information and will follow applicable laws to protect such information, including, for example, the CHIPS Act, the Trade Secrets Act, and the Freedom of Information Act. Please refer to Section IV.C of the **CHIPS Incentives Program – Commercial Fabrication Facilities** Notice of Funding Opportunity (CHIPS-CFF NOFO) for a further discussion of these laws. By submitting this SOI, the potential applicant represents that it has read Section IV.C of the CHIPS-CFF NOFO information and acknowledges and agrees that the information contained in the SOI may be used by DOC in accordance with that section.

Submission Certifications

Attestation

The individual submitting the SOI certifies on behalf of the potential applicant that the data and information submitted and the representations made in this submission are true and correct, to the best of the potential applicant's knowledge as of the date of submission



Attestation

The individual submitting the SOI further certifies that they possess the full legal authority to submit this SOI on behalf of the potential applicant



Public Communications

Steps

- **Attest and Submit**
- Generate PDF
- Confirmation

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Public Communications

Attestation

The individual submitting the SOI acknowledges that neither the potential applicant nor its affiliates may issue any press release or otherwise publicly disclose the status of the SOI or the contents of any communications with DOC without DOC's prior written consent



Next

Financ

Confirmation

You may download a PDF of your Statement of Interest using the link below.

[Download Link](#)

CHIPS

Enviro

Finish

Steps

- ✓ Potential Applicant Information
- ✓ Project Information
- ✓ Generate PDF
- **Confirmation**

Workforce Management

SECTION STATUS

Not Started

Attestation & Submission

SECTION STATUS

Not Started

Full Application

Acknowledgement

SECTION STATUS

Not Started

Get Started

[Application Workspace](#)[Application Team](#)[Submissions](#)

OMB Control Number: 0693-XXXX

Expiration Date: XX/XX/XXXX

[View Burden Statement](#)[Withdraw Submission](#)


▼ Statement of Interest

Acknowledgement**SECTION STATUS**

Submitted

 Submitted**Statement of Interest****SECTION STATUS**

Submitted

 Submitted**Submit Statement of Interest****SECTION STATUS**

Submitted

 Submitted

▼ Pre-Application